

BB02-WF

CUSTOMER PRODUCT SPECIFICATION SHEET



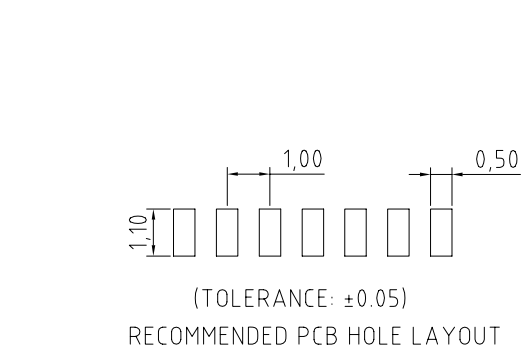
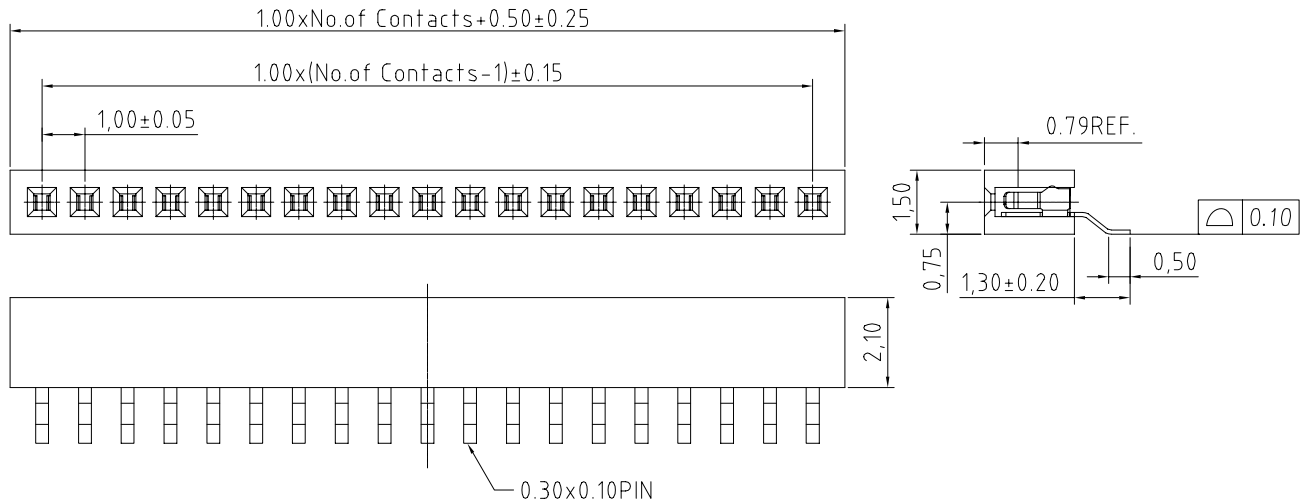
BB02-WF:- 1.00MM (0.039") SOCKET, SINGLE ROW, RIGHT ANGLE, SMT TYPE, 02 TO 35 CONTACTS

SPECIFICATIONS :

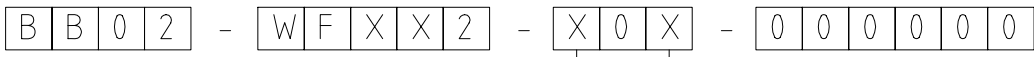
- CURRENT RATING: 1.0AMP Δ
- INSULATOR RESISTANCE: 1000 MEGOHMS MIN. Δ
- DIELECTRIC WITHSTANDING: AC 300 V Δ
- CONTACT RESISTANCE: 20m OHMS MAX. Δ
- OPERATING TEMPERATURE: -40°C TO +105°C
- CONTACT MATERIAL: PHOSPHOR BRONZE
- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- STANDARD: LCP + 30%GF
- PLATING: GOLD OR TIN OVER 30-50U" NICKEL
- SOLDERABILITY IR REFLOW: 280°C FOR 10 SEC
- MANUAL SOLDER: 380°C FOR 3-5 SEC

- MATES WITH: - BB02-YJ BB02-YM
- BB02-YK BB02-YN
- BB02-YL

- NOTES:
1. RECOMMENDED MATING PIN LENGTH = 1.5MM.



HOW TO ORDER



- NO. OF CONTACTS**
02 to 35 Δ
- CONTACT PLATING OPTIONS**
K = GOLD FLASH (STANDARD)
A = 10U" GOLD ON CONTACT/GOLD FLASH ON TAIL
B = 15U" GOLD ON CONTACT/GOLD FLASH ON TAIL
T = BRIGHT TIN
M = MATT TIN
- PACKAGING OPTIONS**
3 - TUBE
4 - TUBE & FILM
6 - TAPE & REEL
7 - TAPE & REEL & FILM

REV.	DATE & DRN
10	26/02/09 - NYW RELEASE
11	02/07/09 - NYW CHANGE CURRENT RATING
12	29/02/09 - NYW ADD PLATING OPTIONS A & B
13	30/10/10 - NYW CHANGE MAX. PIN# 40 TO 35

Scale: 8:1	THIRD ANGLE	Unstated Tolerances: X. ± 0.30 X ± 0.25 .XX ± 0.15 XXX ± 0.10	Material SEE NOTE
Drawn: CHC			
App'd: XXX	Title: SOCKET	NOT TO SCALE	
Date: 20 OCT '10	Revision: 1.3	Unit: mm	

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Type BB02-WF
BB02-WF
Drawing Number:
Sheet 1 of 1
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